NF

hFE

Noise Figure

TUNG-SOL -

TRANSISTOR ELECTRICAL SYMBOLS

SMALL SIGNAL AND HIGH FREQUENCY PARAMETERS

^h ob	Common base - output admittance, input AC open-circuited
h _{ib}	Common base - input impedance, output AC short-circuited
h _{rb}	Common base - reverse voltage transfer ratio, input AC open-circuited
^h fb ^h fe ^h fc	Common base Common emitter Common collector Common collector
h _{oe} ,h;	Examples of other corresponding common emitter symbols
f _{ab}	Common base the frequency at which the magnitude of the small-signal short-circuit forward current transfer ratio is 0.707 of its low frequency value.
C _{ob}	Collector to base Capacitance measured across the output terminals with the input AC open-circuited.
r _b	Base spreading resistance
G_{e}	Common emitter Power Gain (use $G_{\mbox{\scriptsize b}}$ for common base)

SWITCHING CHARACTERISTICS AT SPECIFIED BIAS

t _d	Ohmic delay time
tr	Rise time These depend on both trans-
t_s	Storage time istor and circuit parameters
tf	Fall time
V _{CE} (SAT.)	Saturation voltage at specified $I_{\hbox{\scriptsize C}}$ and $I_{\hbox{\scriptsize B}}.$ This is defined only within the collector saturation region.

Common emitter - static value of short-circuit forward

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current transfer ratio. hFE = 1C

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TRANSISTOR ELECTRICAL SYMBOLS - CONT'D

SWITCHING CHARACTERISTICS - cont'd AT SPECIFIED BIAS

h_{FF} (INV) Inverse hff (emitter and collector leads switched)

Large-signal value of h_{fe} Large-signal values of parameters are indicated by proper symbol and subscripts, with addition of a bar over the symbol. hfe

DC MEASUREMENTS

DC currents into collector, emitter, or base terminal IC. IE. IB

Voltage collector to base, or emitter to base V_{CB} , V_{FB}

Voltage collector to emitter VCE

Voltage base to emitter VBE

Breakdown voltage, collector to base junction reverse BV_{CBO}

biased, emitter open-circuited (value of 10 should be

specified)

Voltage collector to emitter, at zero base current, with V_{CEO}

the collector junction reverse biased. Specify 10.

Breakdown voltage, collector to emitter, with base open-**BV**CEO

circuited. This may be a function of both "m" (the charge carrier multiplication factor) and the hfb of the tran-

sistor. Specify Ic.

Similar to $\ensuremath{V_{\text{CFO}}}$ except a resistor of value "R" between base and emitter VCER

Similar to V_{CFO} but base shorted to emitter VCES

Punch-through voltage, collector to base voltage at VPT

which the collector space charge layer has widened until it contacts the emitter junction. At voltages

above punch-through, $V_{PT} = V_{CB} - V_{EB}$

Supply Voltage collector to base V_{CCB}

Supply voltage collector to emitter VCCE

Supply voltage base to emitter VRRF

NOTE - third subscript may be omitted if no confusion results.

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TRANSISTOR ELECTRICAL SYMBOLS - CONT'D

DC MEASUREMENTS - cont'd

¹€o,¹cBo	Collector current when collector junction is reverse
	biased and emitter is DC open-circuited.

1_{EO, 1</sup>_{EBO} Emitter current when emitter junction is reverse biased and collector is DC open-circuited.}

1_{CEO} Collector current with collector junction reverse

biased and base open-circuited

I_{CES} Collector current with collector junction reverse

biased and base shorted to emitter.

I_{ECS} Emitter current with emitter junction reverse biased

and base shorted to collector.

NOTE:

SUBSCRIPTS FOR MULTI-ELECTRODE DEVICES ARE DEVELOPED BY NUMERIC ADDITIONS TO THE SUBSCRIPTS. SIMILAR ELECTRODES MAY BE NUMBERED IN SEQUENCE FROM THE INTENDED INPUT TO THE INTENDED OUTPUT ELECTRODES. EXAMPLES: $v_{\rm EB2}$, $v_{\rm B2}$, $v_{\rm CB2}$, $v_{$

NOTE:

REVERSE BIASED JUNCTION MEANS BLASED FOR CURRENT FLOW IN THE HIGH RESISTANCE DIRECTION.